



Product Specification

DESCRIPTION

The GLF72525 Load Switch is a fully integrated 4 A NMOS power load switch with I_OSmart[™] advanced technology. The device is targeted for the mobile computing and data storage markets as a high performance solution for load switch applications.

The GLF72525 has a constant low on-resistance of 9.0 m Ω at the full input voltage range. The fixed rise time helps prevent undesirable inrush current when turned on and the internal EN pin pulldown resistor ensures the device remains in the shutdown mode when disabled. In shutdown mode the GLF72525 draws only 14 nA typical at 3.6 V input supply voltage.

The GLF72525 features a reverse current blocking protection, when GLF72525 is disabled. This function can prevents reverse current flowing from the output to the input source.

The GLF72525 is available in a wafer level chip scale package (WLCSP) measuring 0.97 mm x 1.47 mm x 0.55 mm with a 0.5 mm pitch. This allows the user to save board space and increase cost savings.

FEATURES

• Supply Voltage Range: 0.7 V to 3.6 V

• Low R_{ON}: 9.0 mΩ Typ

Iout Max: 4 A

Ultra-Low I₀:

 \circ 5.6 μ A Typ at 0.7 V_{IN}

3.8 µA Typ at 0.8 V_{IN}

8.8 μA Typ at 3.6 V_{IN}

Ultra-Low I_{SD}: 14 nA Typ @ 3.6 V_{IN}

Controlled V_{OUT} Turn-on Time

111 µs at 0.7 V_{IN}

113 µs at 0.8 V_{IN}

87 µs at 3.6 V_{IN}

Internal EN Pull-Down Resistor

Integrated Output Discharge Switch

Reverse Current Blocking Protection When Disabled

Operating Temperature Range: - 40 °C to 105 °C

• HBM: 8 kV, CDM: 2 kV

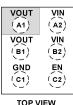
• 0.97 mm x 1.47 mm x 0.55 mm, 6 Bumps Wafer Level Chip Scale Package

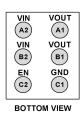
APPLICATIONS

- · Data Storage, SSD
- Wearables
- Low Power Subsystems

PACKAGE

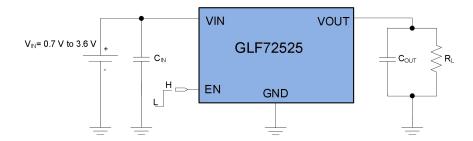






0.97 mm x 1.47 mm x 0.55 mm, 0.5 mm Pitch

APPLICATION DIAGRAM



DEVICE ORDERING INFORMATION

Part Number	Top Mark	R _{oℕ} Typ. at Vin Range	Output Discharge	EN Activity	
GLF72525	FJ	9.0 mΩ	85 Ω	High	

FUNCTIONAL BLOCK DIAGRAM

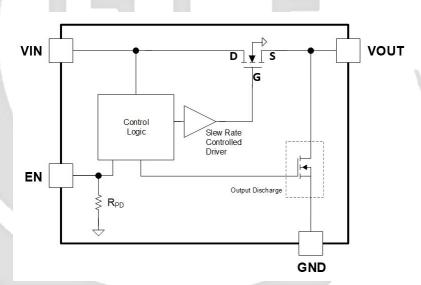


Figure 1. Functional Block Diagram

PIN CONFIGURATION

VOUT	VIN	VIN	VOUT
(A1)	(A2)	(A2)	(A1)
_'	\ _'		
VOUT	VIN	VIN	VOUT
(B1)	(B2)	(B2)	(B1)
_/	_/		
GND	EN	EN	GND
(C1)	(C2)	(C2)	(C1)
	(02)	(02)	
TOP V	'IFW	BOTTO	M VIEW

PIN DEFINITION

Pin#	Name	Description
A1, B1	V _{OUT}	Switch Output
A2, B2	V _{IN}	Switch Input. Supply Voltage for IC
C1	GND	Ground
C2	EN	Enable to control the switch

Figure 2. 0.97 mm x 1.47 mm x 0.55 mm WLCSP



ABSOLUTE MAXIMUM RATINGS

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol		Min.	Max.	Unit	
VIN, VOUT, EN	Each Pin Voltage Range to GND)	-0.3	4	V
I _{оит}	Maximum Continuous Switch Cu	Maximum Continuous Switch Current			
P _D	Power Dissipation at T _A = 25°C		1.2	W	
T _{STG}	Storage Junction Temperature	-65	150	°C	
θ_{JA}	Thermal Resistance, Junction to	Thermal Resistance, Junction to Ambient			
FOD	Electrostatic Discharge	Human Body Model, JESD22-A114	8		137
ESD	Capability	Charged Device Model, JESD22-C101	2		kV

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min.	Max.	Unit
VIN	Supply Voltage	0.7	3.6	V
T _A	Ambient Operating Temperature	-40	+105	°C





ELECTRICAL CHARACTERISTICS

 V_{IN} = 0.7 V to 3.6 V and T_A = 25 °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Basic Oper	ation		'	1		•
		EN = Enable, I _{OUT} = 0 mA, V _{IN} = 0.7 V		5.6		
		EN = Enable, I _{OUT} = 0 mA, V _{IN} = 0.8 V		3.8		
		EN = Enable, I _{OUT} = 0 mA, V _{IN} = 1.5 V		3.1		1
		EN = Enable, I _{OUT} = 0 mA, V _{IN} = 2.5 V		5.1		1.
lQ	Quiescent Current	EN = Enable, I _{OUT} = 0 mA, V _{IN} = 3.0 V		6.5		μA
		EN = Enable, I _{OUT} = 0 mA, V _{IN} = 3.6 V		8.8		1
		EN = Enable, I _{OUT} = 0 mA, V _{IN} = 3.6 V, Ta = 85 °C		16		1
		EN = Enable, I _{OUT} = 0 mA, V _{IN} = 3.6 V, T _A = 105 °C		39		1
		EN = Disable, I _{OUT} = 0 mA, V _{IN} = 0.7 V		6	20	
		EN = Disable, I _{OUT} = 0 mA, V _{IN} = 0.8 V		6		1
		EN = Disable, I _{OUT} = 0 mA, V _{IN} = 1.5 V		7		1
		EN = Disable, I _{OUT} = 0 mA, V _{IN} = 2.5 V		8		nA
I_{SD}	Shutdown Current	EN = Disable, I _{OUT} = 0 mA, V _{IN} = 3.0 V		9		1
		EN = Disable, I _{OUT} = 0 mA, V _{IN} = 3.6 V		14	35	1
		EN = Disable, I _{OUT} = 0 mA, V _{IN} = 3.6 V, Ta = 85 °C		550		
		EN = Disable, I _{OUT} = 0 mA, V _{IN} = 3.6 V, T _A = 105 °C		2.1		μA
		T _A = 25 °C		9	12	
R _{on}	On-Resistance	V _{IN} = 0.7 V to 3.6 V		10		mΩ
		I_{OUT} = 300 mA T_{A} = 105 °C		11		
R _{DSC}	Output Discharge Resistance	EN= Low, I _{FORCE} = 10 mA		85		Ω
		V _{IN} = 0.7 V to 1.5 V	0.7			V
V _{IH}	EN Input Logic High Voltage	V _{IN} = 1.5 V to 3.6 V	1.1			V
.,		V _{IN} = 0.7 V to 1.5 V	/		0.15	V
V_{IL}	EN Input Logic Low Voltage	V _{IN} = 1.5 V to 3.6 V	7		0.4	V
R _{EN}	EN pull down resistance	V _{EN} = 3.3 V		10		ΜΩ
Switching (Characteristics (1)			1		
		V _{IN} = 0.7 V		40		
		V _{IN} = 0.8 V		52		1
t_{dON}	Turn-On Delay Time	V _{IN} = 1.2 V		48		1
	R _{OUT} = 150 Ω, C _{OUT} = 5.0 μ F	V _{IN} = 2.5V		14		
		V _{IN} = 3.6 V		5		-
		V _{IN} = 0.7 V		71		
		V _{IN} = 0.8 V		61		
t_R	V _{OUT} Rise Time R _{OUT} = 150 Ω, C _{OUT} = 5.0 μ F	V _{IN} = 1.2 V		65	µ	μs
	Κουτ - 130 Ω, Οουτ - 3.0 μΓ	V _{IN} = 2.5V		77		
		V _{IN} = 3.6 V		82		1
		V _{IN} = 0.7 V		8		†
	Turn-Off Delay Time	V _{IN} = 0.8 V		4		1
t_{dOFF}	R _{OUT} = 150 Ω, C _{OUT} = 5.0 μF	V _{IN} = 1.2 V		3		
		V _{IN} = 2.5V		3		

ELECTRICAL CHARACTERISTICS (continued)

 V_{IN} = 0.8 V to 3.6 V and T_A = 25 °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Switching	Switching Characteristics (1) (continued)					
		V _{IN} = 0.7 V		86		
		V _{IN} = 0.8 V		82		
t _F	V_{OUT} Fall Time R_{OUT} = 150 Ω, C_{OUT} = 5.0 μF	V _{IN} = 1.2 V		91		μs
	1.001 1.00 12, 0001 0.0 p.	V _{IN} = 2.5V		99		
		V _{IN} = 3.6 V		105		

Notes: 1. By design; characterized, not production tested. $t_{ON} = t_{dON} + t_{R}$, $t_{OFF} = t_{dOFF} + t_{F}$

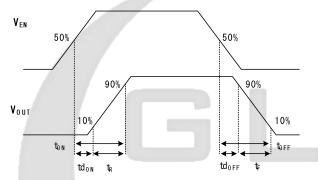


Figure 3. Timing Diagram

TYPICAL PERFORMANCE CHARACTERISTICS

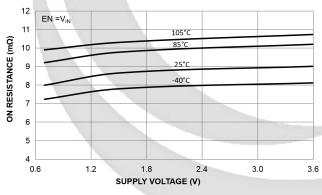


Figure 4. On-Resistance vs. Supply Voltage

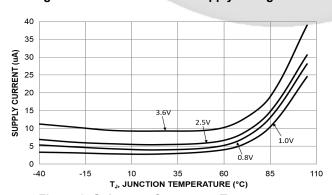


Figure 6. Quiescent Current vs. Temperature

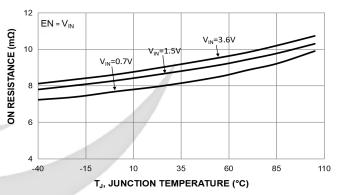


Figure 5. On-Resistance vs. Temperature

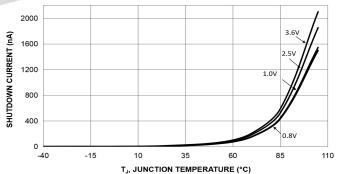
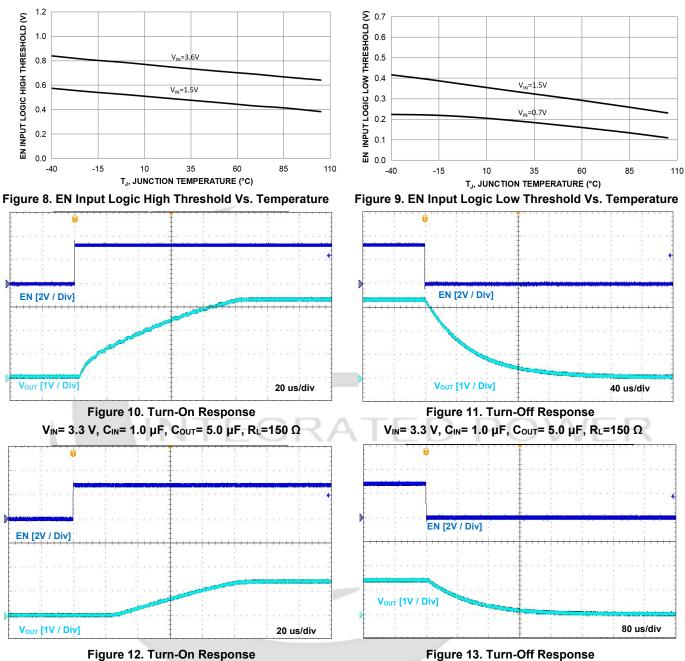


Figure 7. Shutdown Current vs Temperature

GLF72525



Ultra-Low Current Consumption N-channel Power Load Switch INTEGRATED POWER with Low Input Voltage Range and Reverse Current Blocking



 V_{IN} = 0.7 V, C_{IN} = 1.0 μ F, C_{OUT} = 5.0 μ F, R_L =150 Ω

GLF72525



Ultra-Low Current Consumption N-channel Power Load Switch INTEGRATED POWER with Low Input Voltage Range and Reverse Current Blocking

APPLICATION INFORMATION

The GLF72525 is a fully integrated 4 A NMOS power load switch with fixed slew rate control to limit the inrush current during turn on. Each device is capable of operating over a wide input range with very low on-resistance to reduce conduction loss. In the off state, these devices consume very low leakage current, avoiding unwanted standby current from the input power supply. The GLF72525 is available in the 0.97 mm x 1.47 mm wafer level chip scale package with 6 bumps at 0.5 mm pitch to save space in compact applications.

Input Capacitor

A capacitor is recommended to be placed close to the V_{IN} pin to reduce the voltage drop on the input power rail caused by transient inrush current at start-up. A higher input capacitor value can be used to further attenuate the input voltage drop.

Output Capacitor

An output capacitor is recommended to minimize voltage undershoot on the output pin during the transition when the switch is turned off. Undershoot can be caused by parasitic inductance from board traces or intentional load inductances. If load inductances do exist, use of an output capacitor can improve output voltage stability and system reliability. The Cout capacitor should be placed close to the VOUT and GND pins.

Reverse Current Blocking

The GLF72525 has a built-in reverse current blocking protection, when the device is disabled. The reverse current blocking protection is activated to prevent the reverse current from the VOUT to the VIN source.

EN pin

The GLF72525 can be activated by EN pin high. Note that the EN pin has an internal pull-down resistor to maintain a reliable status without EN signal applied from an external controller.

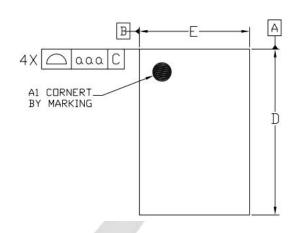
Output Discharge Function

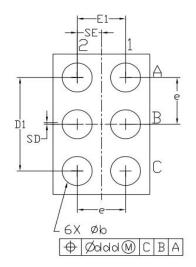
The GLF72525 has an internal discharge N-channel FET switch on the VOUT node. When EN signal turns the main power FET to an off state, the N-channel switch turns on to discharge an output capacitor quickly.

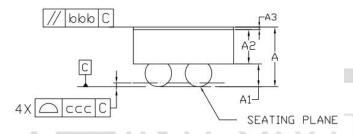
Board Layout

All traces should be as short as possible to minimize parasitic inductance effect. Wide traces for VIN, VOUT, and GND will help reduce signal degradation and parasitic effects during dynamic operations as well as improve the thermal performance at high load current.

PACKAGE OUTLINE





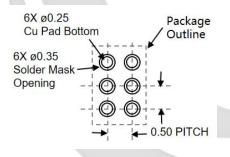


	Dimens	ional R	ef.	
REF.	Min.	Nom.	Max.	
Α	0.500	0.550	0.600	
Α1	0.225	0.250	0.275	
A2	0.250	0.275	0.300	
Α3	0.020	0.025	0.030	
D	1.460	1.470	1.485	
Ε	0.960	0.970	0.985	
D1	0.950	1.000	1.050	
E1	0.450	0.500	0.550	
Ь	0.260	0.310	0.360	
е	0	.500 BS	·C	
SD	0	.000 BS	·C	
SE	0	.250 BSC		
Τc	ol. of Fo	rm&Pos	sition	
aaa		0.10		
ььь		0.10		
CCC		0.05		

0.05

ddd

Recommended Footprint



Notes

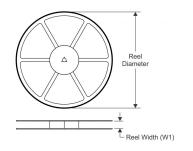
- 1. ALL DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGRESS)
- 2. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M-1994.
- 3. A3: BACKSIDE LAMINATION

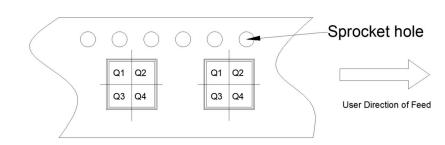


TAPE AND REEL INFORMATION

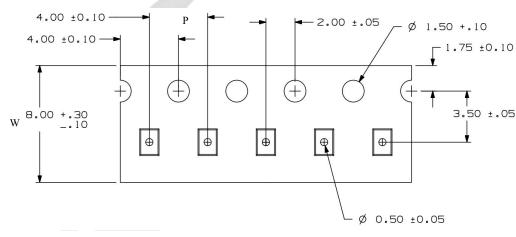
REEL DIMENSIONS

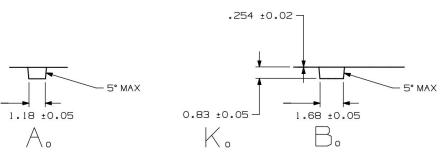
QUADRANT ASSIGNMENTS PIN 1 ORIENTATION TAPE





TAPE DIMENSIONS





Device	Package	Pins	SPQ	Reel Diameter (mm)	Reel Width W1	A0	В0	K0	Р	w	Pin1
GLF72525	WLCSP	6	3000	180	9	1.18	1.68	0.83	4	8	Q1

Remark:

- A0: Dimension designed to accommodate the component width
- B0: Dimension designed to accommodate the component length
- C0: Dimension designed to accommodate the component thickness
- W: Overall width of the carrier tape
- P: Pitch between successive cavity centers

GLF72525



Ultra-Low Current Consumption N-channel Power Load Switch INTEGRATED POWER with Low Input Voltage Range and Reverse Current Blocking

SPECIFICATION DEFINITIONS

Document Type	Meaning	Product Status
Target Specification	This is a target specification intended to support exploration and discussion of critical needs for a proposed or target device. Spec limits including typical, minimum, and maximum values are desired, or target, limits. GLF reserves the right to change limits at any time without warning or notification. A target specification in no way guarantees future production of the device in question.	Design / Development
Preliminary Specification	This is a draft version of a product specification. The specification is still under internal review and subject to change. GLF reserves the right to change the specification at any time without warning or notification. A preliminary specification in no way guarantees future production of the device in question.	Qualification
Product Specification	This document represents the anticipated production performance characteristics of the device.	Production

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